

#### 3.2x2.4mm RIGHT ANGLE SMD CHIP LED **LAMP**

PRELIMINARY SPEC

Part Number: KPEKA-3224CGCK

Green

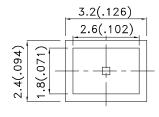
#### **Features**

- 3.2mmx2.4mm RIGHT ANGLE SMT LED, 2.4mm THICKNESS.
- LOW POWER CONSUMPTION.
- WIDE VIEWING ANGLE.
- IDEAL FOR BACKLIGHT AND INDICATOR.
- VARIOUS COLORS AND LENS TYPES AVAILABLE.
- PACKAGE: 1500PCS / REEL.
- MOISTURE SENSITIVITY LEVEL : LEVEL 4.
- RoHS COMPLIANT.

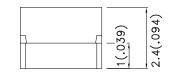
#### Description

The Green source color devices are made with InGaAIP on GaAs substrate Light Emitting Diode.

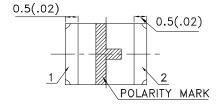
### **Package Dimensions**

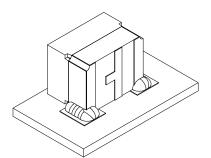












- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is  $\pm 0.2 (0.0079")$  unless otherwise noted.
- 3. Specifications are subject to change without notice.4. The device has a single mounting surface. The device must be mounted according to the specifications.





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### **Selection Guide**

Part No.	Dice	Lens Type	lv (mcd) [2] @ 20mA		Viewing Angle [1]
			Min.	Тур.	201/2
KPEKA-3224CGCK	Green (InGaAIP)	WATER CLEAR	36	60	90°

- 1. 01/2 is the angle from optical centerline where the luminous intensity is 1/2 the optical centerline value.
  2. Luminous intensity/ luminous Flux: +/-15%.

### Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Green	574		nm	IF=20mA
λD [1]	Dominant Wavelength	Green	570		nm	IF=20mA
Δλ1/2	Spectral Line Half-width	Green	20		nm	IF=20mA
С	Capacitance	Green	15		pF	VF=0V;f=1MHz
VF [2]	Forward Voltage	Green	2.1	2.5	V	IF=20mA
lr	Reverse Current	Green		10	uA	V <sub>R</sub> =5V

#### Notes:

1.Wavelength: +/-1nm. 2. Forward Voltage: +/-0.1V.

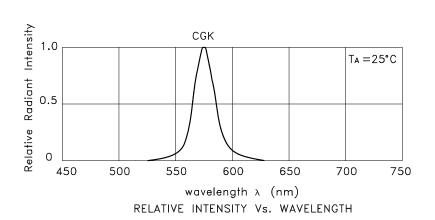
Absolute Maximum Ratings at TA=25°C

Parameter	eter Green		
Power dissipation	75	mW	
DC Forward Current	30	mA	
Peak Forward Current [1]	150	mA	
Reverse Voltage	5	V	
Operating Temperature	-40°C To +85°C		
Storage Temperature	-40°C To +85°C		

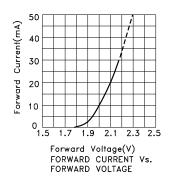
Note: 1. 1/10 Duty Cycle, 0.1ms Pulse Width.

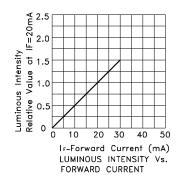
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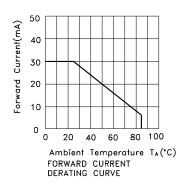
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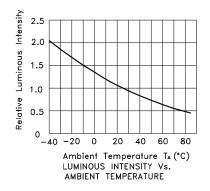


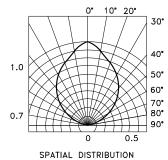
## Green KPEKA-3224CGCK











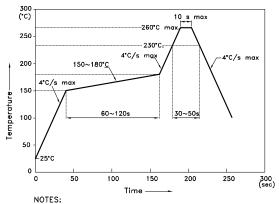
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#### **KPEKA-3224CGCK**

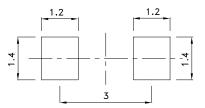
Reflow Soldering Profile For Lead-free SMT Process.



- NOTES:

  1.We recommend the reflow temperature 245°C(+/-5°C).The maximum soldering temperature should be limited to 260°C. 2.Don't cause stress to the epoxy resin while it is exposed to high temperature.
   3.Number of reflow process shall be 2 times or less.

**Recommended Soldering Pattern** (Units: mm; Tolerance: ± 0.1)



### **Tape Specifications** (Units: mm)

TAPE 4.0±0.05 0.23±0.05 2.0±0.05 4.0±0.1 2.55±0.1 8.0±0.2 .5±0.

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